



N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

#### **Features**

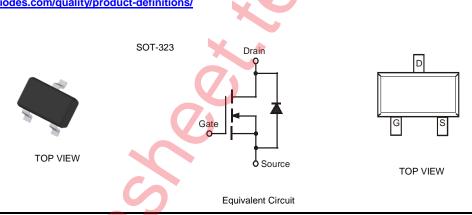
- Low-On Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotiveproducts/.

- This part is qualified to JEDEC standards (as references in AEC-Q101) for High Reliability.
- https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)



# Ordering Information (Note 4)

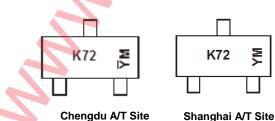
	Part Number		Case	Packaging		
	2N7002W-7-F		SOT-323	3000/Tape & Reel		
Notes:	Notes: 1 No purposely added lead Fully FLI Directive 2002/95/FC (RoHS) 2011/65/FLI (RoHS 2) & 2015/863/FLI (RoHS 3) compliant					

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# Marking Information





K72 = Product Type Marking Code YM = Date Code Marking for SAT (Shanghai Assembly/ Test site)

YM = Date Code Marking for CAT (Chengdu Assembly/ Test site) Y or  $\overline{Y}$  = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Date Code Key

Year	2012		2013		2014	20	15	2016		2017	2	2018
Code	Code Z		А		В	(	0	D		E		F
Month	Jan	Feb	Mar	Apr	Mav	Jun	Jul	Aug	Sep	Oct	Nov	Dec



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteris	tic	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Drain-Gate Voltage $R_{GS} \le 1.0M\Omega$	V <sub>DGR</sub>	60	V	
Gain-Source Voltage	Continuous Pulsed	V <sub>GSS</sub>	±20 ±40	V
Drain Current (Note 5)	Continuous Continuous @ +100°C Pulsed	Ι <sub>D</sub>	115 73 800	mA

## **Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5) Derating above $T_A = +25^{\circ}C$	PD	200 1.60	mW mW
Thermal Resistance, Junction to Ambient	R <sub>0JA</sub>	625	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	۵°

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)							·
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	60	70	_	V	$V_{GS} = 0V, I_D = 10\mu A$
Zero Gate Voltage Drain Current @ T <sub>C</sub> = +125°C	@ T <sub>C</sub> = +25°C	I <sub>DSS</sub>	_	_	1.0 500	μA	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Body Leakage		IGSS	_	_	±10	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage		V <sub>GS(th)</sub>	1.0	—	2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	@ T <sub>J</sub> = +25°C	<b>D</b>		1.8	7.5	Ω	V <sub>GS</sub> = 5.0V, I <sub>D</sub> = 0.05A
@ T <sub>j</sub> = +125°C		R <sub>DS(ON)</sub>	_	2.6	13.5	12	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.5A
On-State Drain Current		I <sub>D(ON)</sub>	0.5	1.0	_	Α	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 7.5V
Forward Transconductance		<b>g</b> fs	80			mS	$V_{DS} = 10V, I_D = 0.2A$
DYNAMIC CHARACTERISTICS (Note 7)							·
Input Capacitance		Ciss	_	22	50	pF	
Output Capacitance		Coss	_	11	25	pF	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V f = 1.0MHz
Reverse Transfer Capacitance		Crss	_	2.0	5.0	pF	1 = 1.0MHZ
SWITCHING CHARACTERISTICS (Note 7	()						·
Turn-On Delay Time		t <sub>D(ON)</sub>		7.0	20	ns	$V_{DD} = 30V, I_D = 0.2A,$
Turn-Off Delay Time		t <sub>D(OFF)</sub>		11	20	ns	R <sub>L</sub> = 150Ω, V <sub>GEN</sub> = 10V, R <sub>GEN</sub> = 25Ω

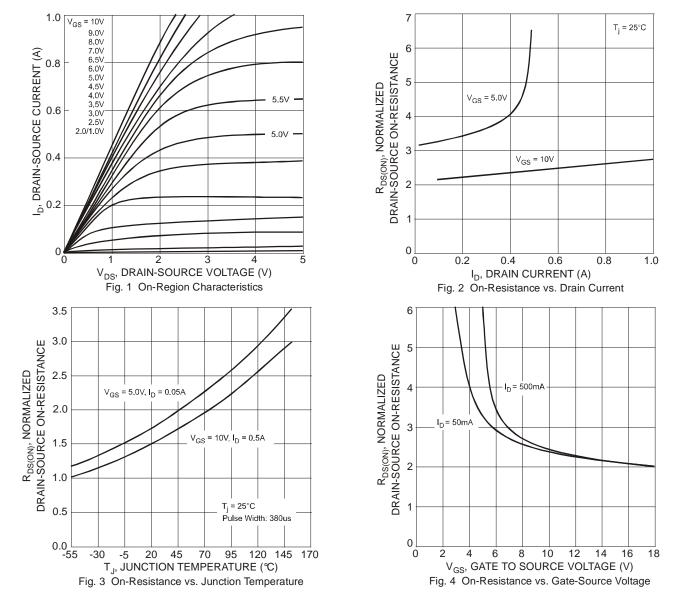
Notes: 5. Device mounted on FR-4 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

6. Short duration pulse test used to minimize self-heating effect.

7. Guaranteed by design. Not subject to production testing.

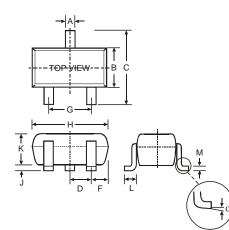


# 2N7002W



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



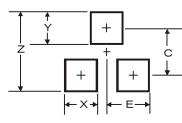
SOT-323						
Dim	Min	Max				
Α	0.25	0.40				
В	1.15	1.35				
С	2.00	2.20				
D	0.65 N	ominal				
F	0.30	0.40				
G	1.20	1.40				
Н	1.80	2.20				
J	<b>J</b> 0.0 0.1					
K	0.90	1.00				
L	0.25	0.40				
М	0.10	0.18				
α	0°	8°				
All Dimensions in mm						



2N7002W

### Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0

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